

# EVLYS LTD. - POWER SEMICONDUCTORS DEVICES - Wholesale and Retail.

## Fast Thyristor Type FDT32-320-24

Low switching losses / Low reverse recovery charge  
Distributed amplified gate for high  $di_T/dt$

Mean on-state current	$I_{TAV}$	320 A	
Repetitive peak off-state voltage	$V_{DRM}$	2000...2400 V	
Repetitive peak reverse voltage	$V_{RRM}$		
Turn-off time	$t_q$	25.0, 32.0, 40.0, 50.0 $\mu s$	
$V_{DRM}, V_{RRM}, V$	2000	2200	2400
Voltage code	20	22	24
$T_j, ^\circ C$	-60...+125		

### MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions
<b>ON-STATE</b>				
$I_{TAV}$	Maximum allowable mean on-state current	A	320 470	$T_c = 85^\circ C$ ; Double side cooled; $T_c = 55^\circ C$ ; Double side cooled; 180° half-sine wave; 50 Hz
$I_{TRMS}$	RMS on-state current	A	502	$T_c = 85^\circ C$ ; Double side cooled; 180° half-sine wave; 50 Hz
$I_{TSM}$	Surge on-state current	kA	6.3 7.0	$T_j = T_{jmax}$ $T_j = 25^\circ C$ 180° half-sine wave; $t_p = 10$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$ ; $V_G = 20$ V; $t_{GP} = 50$ $\mu s$ ; $di_G/dt = 1$ A/ $\mu s$
			6.5 7.5	$T_j = T_{jmax}$ $T_j = 25^\circ C$ 180° half-sine wave; $t_p = 8.3$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$ ; $V_G = 20$ V; $t_{GP} = 50$ $\mu s$ ; $di_G/dt = 1$ A/ $\mu s$
$I^2t$	Safety factor	$A^2s \cdot 10^3$	190 240	$T_j = T_{jmax}$ $T_j = 25^\circ C$ 180° half-sine wave; $t_p = 10$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$ ; $V_G = 20$ V; $t_{GP} = 50$ $\mu s$ ; $di_G/dt = 1$ A/ $\mu s$
			170 230	$T_j = T_{jmax}$ $T_j = 25^\circ C$ 180° half-sine wave; $t_p = 8.3$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$ ; $V_G = 20$ V; $t_{GP} = 50$ $\mu s$ ; $di_G/dt = 1$ A/ $\mu s$
<b>BLOCKING</b>				
$V_{DRM}, V_{RRM}$	Repetitive peak off-state and Repetitive peak reverse voltages	V	2000...2400	$T_{jmin} < T_j < T_{jmax}$ ; 180° half-sine wave; 50 Hz; Gate open
$V_{DSM}, V_{RSM}$	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	2100...2500	$T_{jmin} < T_j < T_{jmax}$ ; 180° half-sine wave; single pulse; Gate open
$V_{D}, V_R$	Direct off-state and Direct reverse voltages	V	$0.6 \cdot V_{DRM}$ $0.6 \cdot V_{RRM}$	$T_j = T_{jmax}$ ; Gate open
<b>TRIGGERING</b>				

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$I_{FGM}$	Peak forward gate current	A	6	$T_j = T_{j\ max}$
$V_{RGM}$	Peak reverse gate voltage	V	5	
$P_G$	Gate power dissipation	W	3	$T_j = T_{j\ max}$ for DC gate current
<b>SWITCHING</b>				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/ $\mu$ S	1600	$T_j = T_{j\ max}; V_D = 0.67 \cdot V_{DRM}; I_{TM} = 2 I_{TAV};$ Gate pulse: $I_G = 2\ A; V_G = 20\ V;$ $t_{GP} = 50\ \mu S; di_G/dt = 2\ A/\mu S$
<b>THERMAL</b>				
$T_{stg}$	Storage temperature	$^{\circ}C$	-60...+50	
$T_j$	Operating junction temperature	$^{\circ}C$	-60...+125	
<b>MECHANICAL</b>				
F	Mounting force	kN	9.0...11.0	
a	Acceleration	m/s <sup>2</sup>	50	Device clamped

## CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
<b>ON-STATE</b>					
$V_{TM}$	Peak on-state voltage, max	V	2.80	$T_j = 25\ ^{\circ}C; I_{TM} = 1005\ A$	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.50	$T_j = T_{j\ max};$	
$r_T$	On-state slope resistance, max	m $\Omega$	1.250	$0.5\ \pi\ I_{TAV} < I_T < 1.5\ \pi\ I_{TAV}$	
$I_H$	Holding current, max	mA	500	$T_j = 25\ ^{\circ}C;$ $V_D = 12\ V;$ Gate open	
<b>BLOCKING</b>					
$I_{DRM}, I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	150	$T_j = T_{j\ max};$ $V_D = V_{DRM}; V_R = V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/ $\mu$ S	200, 320, 500, 1000	$T_j = T_{j\ max};$ $V_D = 0.67 \cdot V_{DRM};$ Gate open	
<b>TRIGGERING</b>					
$V_{GT}$	Gate trigger direct voltage, max	V	4.00 2.50 2.00	$T_j = T_{j\ min}$ $T_j = 25\ ^{\circ}C$ $T_j = T_{j\ max}$	$V_D = 12\ V; I_D = 3\ A;$ Direct gate current
$I_{GT}$	Gate trigger direct current, max	mA	500 300 200	$T_j = T_{j\ min}$ $T_j = 25\ ^{\circ}C$ $T_j = T_{j\ max}$	
$V_{GD}$	Gate non-trigger direct voltage, min	V	0.25	$T_j = T_{j\ max}; V_D = 0.67 \cdot V_{DRM};$	
$I_{GD}$	Gate non-trigger direct current, min	mA	10.00	Direct gate current	
<b>SWITCHING</b>					
$t_{gd}$	Delay time, max	$\mu$ S	0.66	$T_j = 25\ ^{\circ}C; V_D = 1000\ V; I_{TM} = I_{TAV};$ $di/dt = 200\ A/\mu S;$	
$t_{gt}$	Turn-on time <sup>2)</sup> , max	$\mu$ S	1.60, 2.00, 2.50, 3.20	Gate pulse: $I_G = 2\ A; V_G = 20\ V;$ $t_{GP} = 50\ \mu S; di_G/dt = 2\ A/\mu S$	
$t_q$	Turn-off time <sup>3)</sup> , max	$\mu$ S	25.0, 32.0, 40.0, 50.0	$dv_D/dt = 50\ V/\mu S$	$T_j = T_{j\ max};$ $I_{TM} = I_{TAV};$ $di_R/dt = -10\ A/\mu S;$ $V_R = 100V;$ $V_D = 0.67\ V_{DRM}$
			32.0, 40.0, 50.0, 63.0	$dv_D/dt = 200\ V/\mu S$	
$Q_{rr}$	Recovered charge, max	$\mu$ C	250	$T_j = T_{j\ max}; I_{TM} = 320\ A;$	

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$t_{rr}$	Reverse recovery time, max	$\mu\text{s}$	4.0	$di_R/dt = -50 \text{ A}/\mu\text{s};$ $V_R = 100 \text{ V}$
$I_{rr}$	Reverse recovery current, max	A	130	

## Thermal

$R_{thjc}$	Thermal resistance, junction to case, max	$^{\circ}\text{C}/\text{W}$	0.0500	Direct current	Double side cooled
$R_{thjc-A}$			0.1100		Anode side cooled
$R_{thjc-K}$			0.0900		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max	$^{\circ}\text{C}/\text{W}$	0.0060	Direct current	

## Mechanical

m	Weight, max	g	92	
$D_s$	Surface creepage distance	mm (inch)	10.30 (0.405)	
$D_a$	Air strike distance	mm (inch)	6.30 (0.248)	

## Part Numbering Guide

FDT	32	320	24	7	6	5	
1	2	3	4	5	6	7	

1. FDT — Fast Inverter Disc Thyristor
2. Design version
3. Mean on-state current, A
4. Voltage code
5. Critical rate of rise of off-state voltage
6. Group of turn-off time ( $dv_D/dt = 50 \text{ V}/\mu\text{s}$ )
7. Group of turn-on time

## Notes

1) Critical rate of rise of off-state voltage

Symbol of group	4	5	6	7
$(dv_D/dt)_{crit}, \text{ V}/\mu\text{s}$	200	320	500	1000

2) Turn-on time

Symbol of group	6	5	4	3
$t_{gt}, \mu\text{s}$	1.60	2.00	2.50	3.20

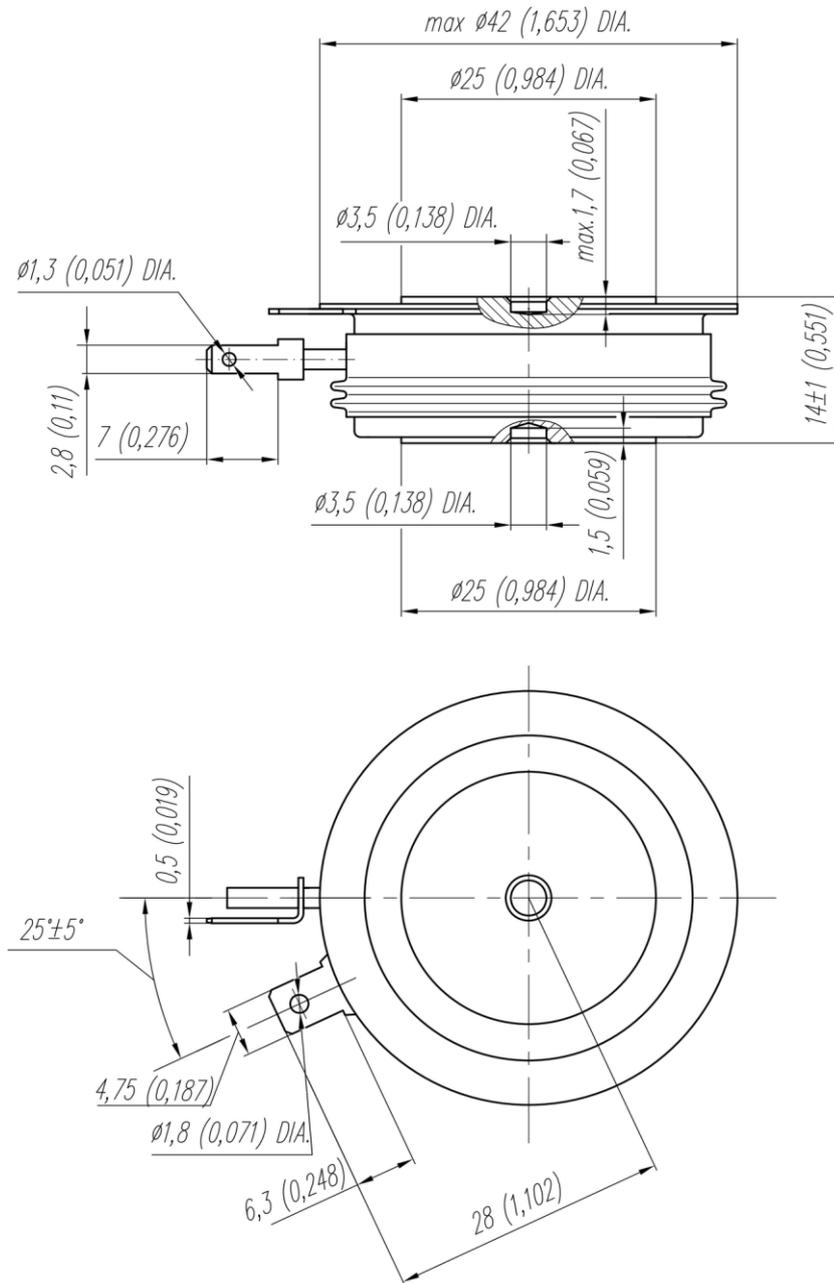
3) Turn-off time ( $dv_D/dt = 50 \text{ V}/\mu\text{s}$ )

Symbol of group	5	4	3	2
$t_q, \mu\text{s}$	25.0	32.0	40.0	50.0

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## OVERALL DIMENSIONS

Package type: T.B2



All dimensions in millimeters (inches)

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